

Description

The AP3400Cl uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_{D} = 4.2A$

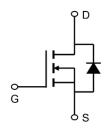
 $R_{DS(ON)} < 42m\Omega$ @ $V_{GS}=10V$

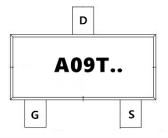
Application

Battery protection

Load switch

Uninterruptible power supply







Package Marking and Ordering Information

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Product ID	Pack	Marking	Qty(PCS)
AP3400CI	SOT-23	A09T	3000

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

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Symbol	Parameter	Max.	Units
VDSS	Drain-Source Voltage	30	V
VGSS	Gate-Source Voltage	±12	V
ID	Continuous Drain Current T _A = 25°C	4.2	Α
ID	Continuous Drain Current T _A = 100℃	2.6	Α
IDM	Pulsed Drain Current	16	Α
P _D	Power Dissipation T _A = 25°C	1.1	W
RθJA	Thermal Resistance, Junction to Case	113.6	°C/W
TJ, TSTG	Operating and Storage Temperature Range	-55 to +150	°C



Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	32	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V,	-	-	1.0	μΑ
IGSS	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.9	1.4	V
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =10V, I _D =4A	-	32	42	
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =4.5V, I _D =3A	-	36	48	mΩ
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =2.5V, I _D =2A -		50	70	
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V,	-	285	-	pF
Coss	Output Capacitance	f=1.0MHz	-	33	-	pF
Crss	Reverse Transfer Capacitance		-	27	-	pF
Qg	Total Gate Charge	V _{DS} =15V, I _D =4A,	-	2.6	-	nC
Q_{gs}	Gate-Source Charge	V _{GS} =4.5V	-	0.6	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	0.9	-	nC
td(on)	Turn-on Delay Time	V .=15V	-	15	-	ns
t _r	Turn-on Rise Time	V_{DS} =15V, I_{D} =2A, R_{GEN} =3 Ω ,	-	42	-	ns
td(off)	Turn-off Delay Time	V _{GS} =4.5V	-	16	-	ns
t _f	Turn-off Fall Time		-	10	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	4	Α
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	16	Α
VSD	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =4A	-	-	1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- $2\sqrt{100}$ The data tested by pulsed , pulse width ≤ 300 us , duty cycle $\leq 2\%$
- 3. The power dissipation is limited by 150 ℃ junction temperature
- $4\sqrt{100}$ The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

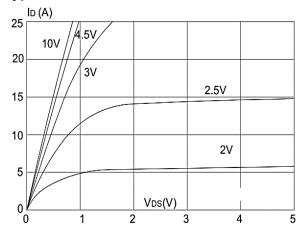


Figure1: Output Characteristics

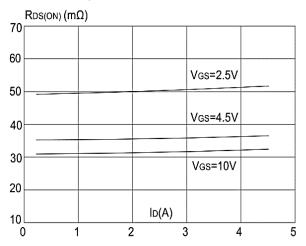


Figure 3:On-resistance vs. Drain Current

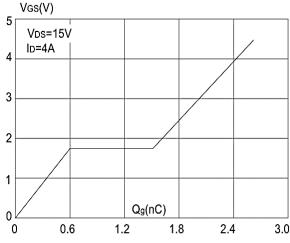


Figure 5: Gate Charge Characteristics

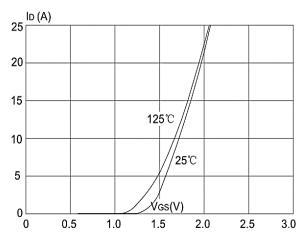


Figure 2: Typical Transfer Characteristics

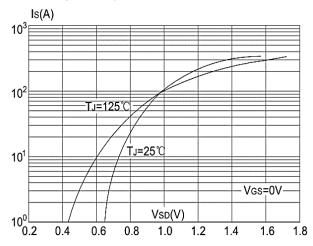


Figure 4: Body Diode Characteristics

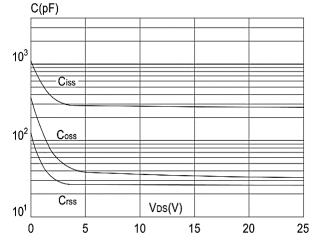


Figure 6: Capacitance Characteristics



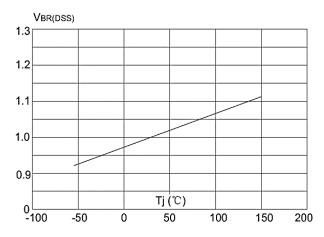


Figure 7: Normalized Breakdown Voltage vs Junction Temperature

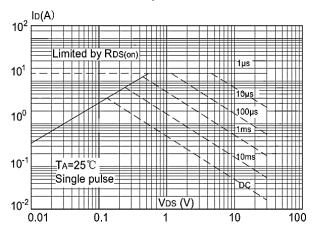


Figure 9: Maximum Safe Operating Area

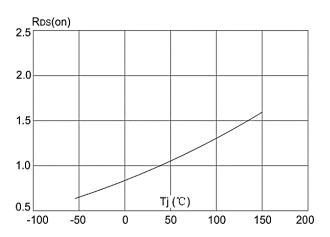


Figure 8: Normalized on Resistance vs.

Junction Temperature

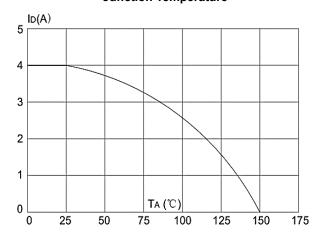


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

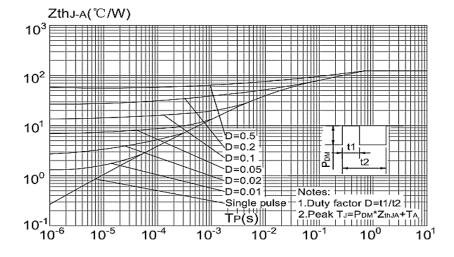
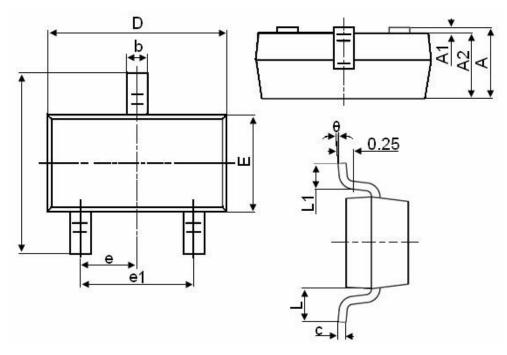


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambien



Package Mechanical Data-SOT23-XC-Single



Cumbal	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
Α	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
С	0.080	0.150		
D	2.800	3.000		
Е	1.200	1.400		
E1	2.250	2.550		
е	0.950TYP			
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		



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Edition	Date	Change
Rve1.0	2020/5/1	Initial release

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